

Absolute Maximum Ratings (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-5.0	V
Collector Current	Ic	-200	mA

Thermal Characteristics – Total Device (@T_A = +25°C unless otherwise specified.)

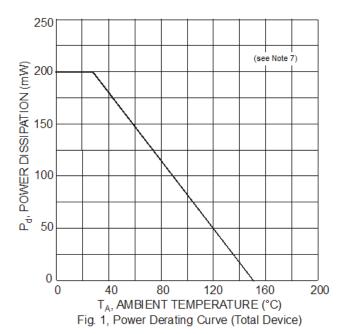
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7) Total Device	P_{D}	200	mW
Thermal Resistance, Junction to Ambient (Note 7)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

Thermal Characteristics - Total Device



^{7.} For a device mounted on minimum recommended pad layout with 1oz copper that is on a single-sided 1.6mm FR4 PCB; the device is measured under still air conditions whilst operating in a steady-state.

^{8.} Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Electrical Characteristics (@TA = +25°C unless otherwise specified)

Characteristic	Symbol	Min	TYP	Max	Unit	Test Condition	
OFF CHARACTERISTICS	1				1	1	
Collector-Base Breakdown Voltage	BV _{CBO}	-40	_	_	V	$I_C = -100\mu A, I_E = 0$	
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-40	_	_	V	$I_C = -1.0 \text{mA}, I_B = 0$	
Emitter-Base Breakdown Voltage	BV _{EBO}	-5.0	_	_	V	$I_E = -100\mu A, I_C = 0$	
Collector Cutoff Current	I _{CEX}	_	_	-50	nA	V _{CE} = -30V, V _{EB(OFF)} = 3.0V	
Base Cutoff Current	I _{BL}	_	_	-50	nA	V _{CE} = -30V, V _{EB(OFF)} = 3.0V	
ON CHARACTERISTICS (Note 9)	I.						
DC Current Gain	hFE	60 80 100 60 30	_	300 — —	_	$I_{C} = -100\mu A, V_{CE} = -1.0V$ $I_{C} = -1.0mA, V_{CE} = -1.0V$ $I_{C} = -10mA, V_{CE} = -1.0V$ $I_{C} = -50mA, V_{CE} = -1.0V$ $I_{C} = -100mA, V_{CE} = -1.0V$	
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	_	-250 -400	mV	$I_C = -10\text{mA}, I_B = -1.0\text{mA}$ $I_C = -50\text{mA}, I_B = -5.0\text{mA}$	
Base-Emitter Saturation Voltage	V _{BE(SAT)}	0.65 —	_	-850 -950	mV	$I_C = -10mA$, $I_B = -1.0mA$ $I_C = -50mA$, $I_B = -5.0mA$	
MATCHING CHARACTERISTICS			_	_	_		
DC Current Gain Matching (Note 10)	h _{FE1} / h _{FE2}	_	1	2	%	$I_C = -2mA$, $V_{CE} = -5V$	
Base-Emitter Voltage Matching (Note 11)	V _{BE1} - V _{BE2}	_	1	2	mV	$I_C = -2mA$, $V_{CE} = -5V$	
Collector-Emitter Saturation Voltage (Note 10)	V _{CE(SAT)1} / V _{CE(SAT)2}	_	1	2	%	I _C = -10mA, I _B = -1.0mA	
Base-Emitter Saturation Voltage (Note 10)	V _{BE(SAT)1} / V _{BE(SAT)2}	_	1	2	%	I _C = -10mA, I _B = -1.0mA	
SMALL SIGNAL CHARACTERISTICS							
Output Capacitance	C _{OBO}	_	_	4.5	pF	$V_{CB} = -5.0V$, $f = 1.0MHz$, $I_E = 0$	
Input Capacitance	C _{IBO}	_	_	10.0	pF	$V_{EB} = -0.5V$, $f = 1.0MHz$, $I_C = 0$	
Input Impedance	h _{IE}	2.0	_	12	kΩ		
Voltage Feedback Ratio	h _{RE}	0.1	_	10	x 10 ⁻⁴	$V_{CE} = 10V, I_{C} = 1.0mA,$	
Small Signal Current Gain	h _{FE}	100	_	400	_	f = 1.0kHz	
Output Admittance	hoE	3.0	_	60	μS		
Current Gain-Bandwidth Product	f _T	250	_	_	MHz	V _{CE} = -20V, I _C = -10mA, f = 100MHz	
Noise Figure	NF	_		4.0	dB	$V_{CE} = -5.0V, I_{C} = -100\mu A,$ $R_{S} = 1.0k\Omega, f = 1.0kHz$	
SWITCHING CHARACTERISTICS							
Delay Time	t _D	_	_	35	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$	
Rise Time	t _R	_	_	35	ns	$V_{BE(OFF)} = 0.5V, I_{B1} = -1.0mA$	
Storage Time	ts	_	_	225	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$	
Fall Time	t _F			75	ns	I _{B1} = I _{B2} = -1.0mA	

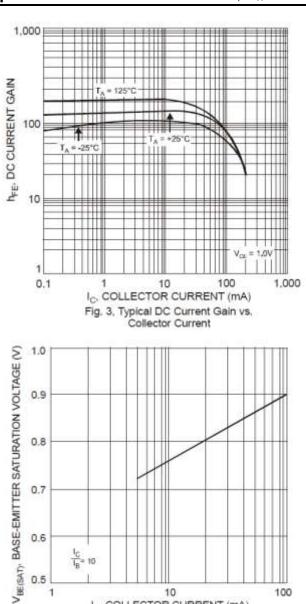
Notes:

^{9.} Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%. 10. Is the ratio of one transistor compared to the other transistor.

^{11.} V_{BE1} - V_{BE2} is the absolute difference of one transistor compared to the other transistor.



Typical Electrical Characteristics (@TA = +25°C unless otherwise specified.)



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I_C. COLLECTOR CURRENT (mA) Fig. 5, Typical Base-Emitter Saturation Voltage vs. Collector Current

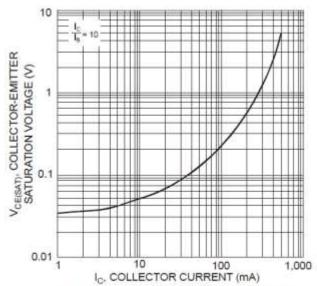
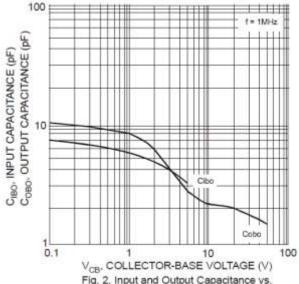


Fig. 4, Typical Collector-Emitter Saturation Voltage vs. Collector Current



0.6

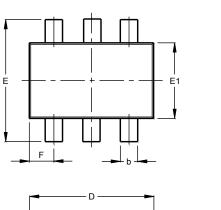
0.5

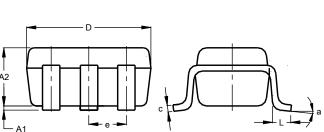
100



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





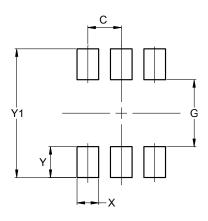
SOT363				
Dim	Min	Max	Тур	
A1	0.00	0.10	0.05	
A2	0.90	1.00	1.00	
b	0.10	0.30	0.25	
C	0.10	0.22	0.11	
D	1.80	2.20	2.15	
E	2.00	2.20	2.10	
E1	1.15	1.35	1.30	
е	0.650 BSC			
F	0.40	0.45	0.425	
L	0.25	0.40	0.30	
а	0°	8°		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363

SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500



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